



High power cycling capability  
Low on-state and switching losses  
Designed for traction and industrial applications

**Phase Control Thyristor  
T933-250-44**

Mean on-state current	$I_{TAV}$		250 A	
Repetitive peak off-state voltage	$V_{DRM}$		3800 ÷ 4400 V	
Repetitive peak reverse voltage	$V_{RRM}$			
Turn-off time	$t_q$		500, 630, 800 $\mu$ s	
$V_{DRM}, V_{RRM}, V$	3800	4000	4200	4400
Voltage code	38	40	42	44
$T_j, ^\circ C$	- 60 ÷ 125			

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	250 293	$T_c=93^\circ C$ ; Double side cooled; $T_c=85^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	392	$T_c=93^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	3.5 4.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			3.5 4.0	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I^2t$	Safety factor	$A^2s \cdot 10^3$	60 80	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=10$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			50 60	$T_j=T_{jmax}$ $T_j=25^\circ C$	180° half-sine wave; $t_p=8.3$ ms; single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	3800÷4400	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3900÷4500	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j=T_{jmax}$ ; Gate open	

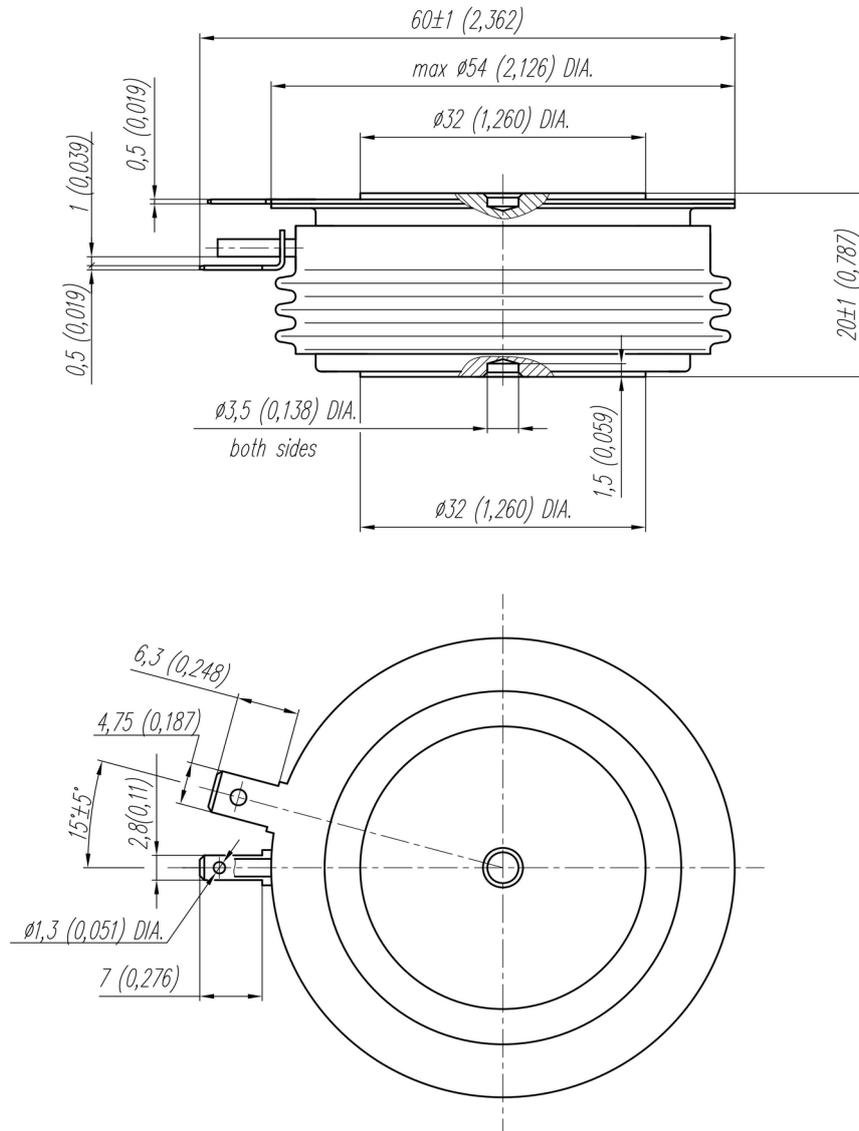
<b>TRIGGERING</b>				
$I_{FGM}$	Peak forward gate current	A	6	$T_j = T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	3	$T_j = T_{j\max}$ for DC gate current
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ s	400	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 500$ A; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	$^{\circ}$ C	-60 ÷ 50	
$T_j$	Operating junction temperature	$^{\circ}$ C	-60 ÷ 125	
<b>MECHANICAL</b>				
F	Mounting force	kN	9.0 ÷ 11.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

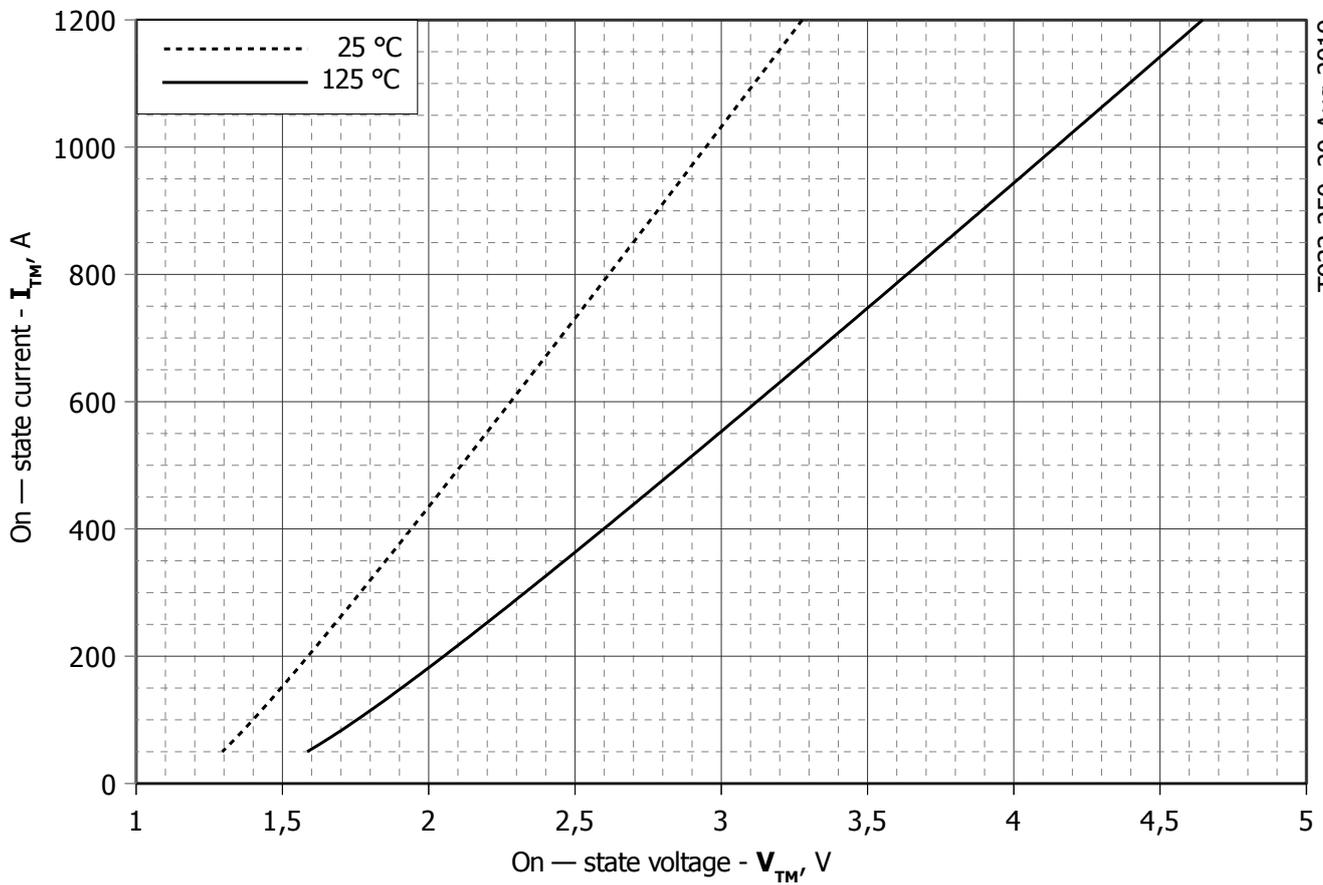
Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	2.60	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 785$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.572	$T_j = T_{j\max}$ ;	
$r_T$	On-state slope resistance, max	m $\Omega$	2.562	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$I_L$	Latching current, max	mA	700	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s	
$I_H$	Holding current, max	mA	300	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open	
<b>BLOCKING</b>					
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	$T_j = T_{j\max}$ ; $V_D = V_{DRM}$ ; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Gate open	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j = T_{j\min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	$T_j = T_{j\min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.55	$T_j = T_{j\max}$ ;	
$I_{GD}$	Gate non-trigger direct current, min	mA	35.00	$V_D = 0.67 \cdot V_{DRM}$ ; Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time, max	$\mu$ s	3.10	$T_j = 25$ $^{\circ}$ C; $V_D = 1500$ V; $I_{TM} = I_{TAV}$ ; $di/dt = 200$ A/ $\mu$ s;	
$t_{gt}$	Turn-on time, max	$\mu$ s	25.0	Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50$ $\mu$ s; $di_G/dt = 2$ A/ $\mu$ s	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	500, 630, 800	$dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}$ ; $I_{TM} = I_{TAV}$ ; $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$	
$Q_{rr}$	Total recovered charge, max	$\mu$ C	1200	$T_j = T_{j\max}$ ; $I_{TM} = 250$ A;	
$t_{rr}$	Reverse recovery time, max	$\mu$ s	30	$di_R/dt = -5$ A/ $\mu$ s;	
$I_{rrM}$	Peak reverse recovery current, max	A	80	$V_R = 100$ V	

<b>THERMAL</b>					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0400	Direct current	Double side cooled
$R_{thjc-A}$			0.0880		Anode side cooled
$R_{thjc-K}$			0.0720		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0080	Direct current	
<b>MECHANICAL</b>					
w	Weight, max	g	180		
$D_s$	Surface creepage distance	mm (inch)	19.44 (0.765)		
$D_a$	Air strike distance	mm (inch)	12.10 (0.476)		

<b>PART NUMBERING GUIDE</b>							<b>NOTES</b>																						
T	933	250	44	A2	B2	N																							
1	2	3	4	5	6	7																							
1. Phase Control Thyristor							1) Critical rate of rise of off-state voltage																						
2. Design version							<table border="1"> <thead> <tr> <th>Symbol of Group</th> <th>P2</th> <th>K2</th> <th>E2</th> <th>A2</th> <th>T1</th> <th>P1</th> <th>M1</th> </tr> </thead> <tbody> <tr> <td><math>(dv_D/dt)_{crit}</math>, V/μs</td> <td>200</td> <td>320</td> <td>500</td> <td>1000</td> <td>1600</td> <td>2000</td> <td>2500</td> </tr> </tbody> </table>							Symbol of Group	P2	K2	E2	A2	T1	P1	M1	$(dv_D/dt)_{crit}$ , V/μs	200	320	500	1000	1600	2000	2500
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$(dv_D/dt)_{crit}$ , V/μs	200	320	500	1000	1600	2000	2500																						
3. Mean on-state current, A							2) Turn-off time ( $dv_D/dt=50$ V/μs)																						
4. Voltage code							<table border="1"> <thead> <tr> <th>Symbol of Group</th> <th>E2</th> <th>C2</th> <th>B2</th> </tr> </thead> <tbody> <tr> <td><math>t_q</math>, μs</td> <td>500</td> <td>630</td> <td>800</td> </tr> </tbody> </table>							Symbol of Group	E2	C2	B2	$t_q$ , μs	500	630	800								
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6. Turn-off time ( $dv_D/dt=50$ V/μs)																													
7. Ambient conditions: N – normal; T – tropical																													



All dimensions in millimeters (inches)



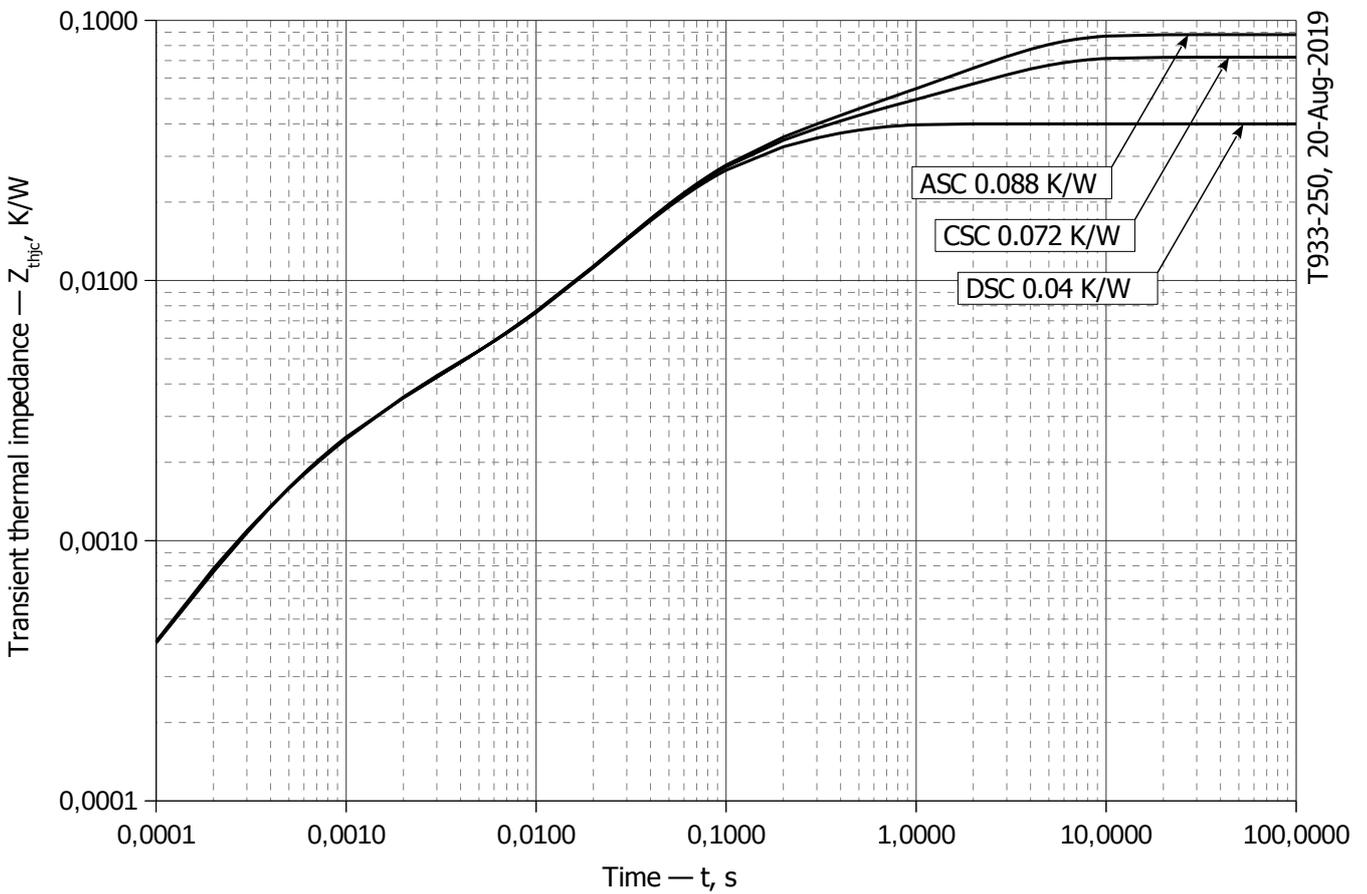
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
<b>A</b>	1.1028641	1.2420662
<b>B</b>	0.0015663	0.0023643
<b>C</b>	0.0212570	0.0438527
<b>D</b>	0.0041548	0.0073651

**On-state characteristic model (see Fig. 1)**



T933-250, 20-Aug-2019

**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.01423	0.01906	0.003576	0.002535	-4.666e-005	0.0006479
$\tau_i$ , s	0.265	0.05901	0.03499	0.001252	0.000001	0.0002488

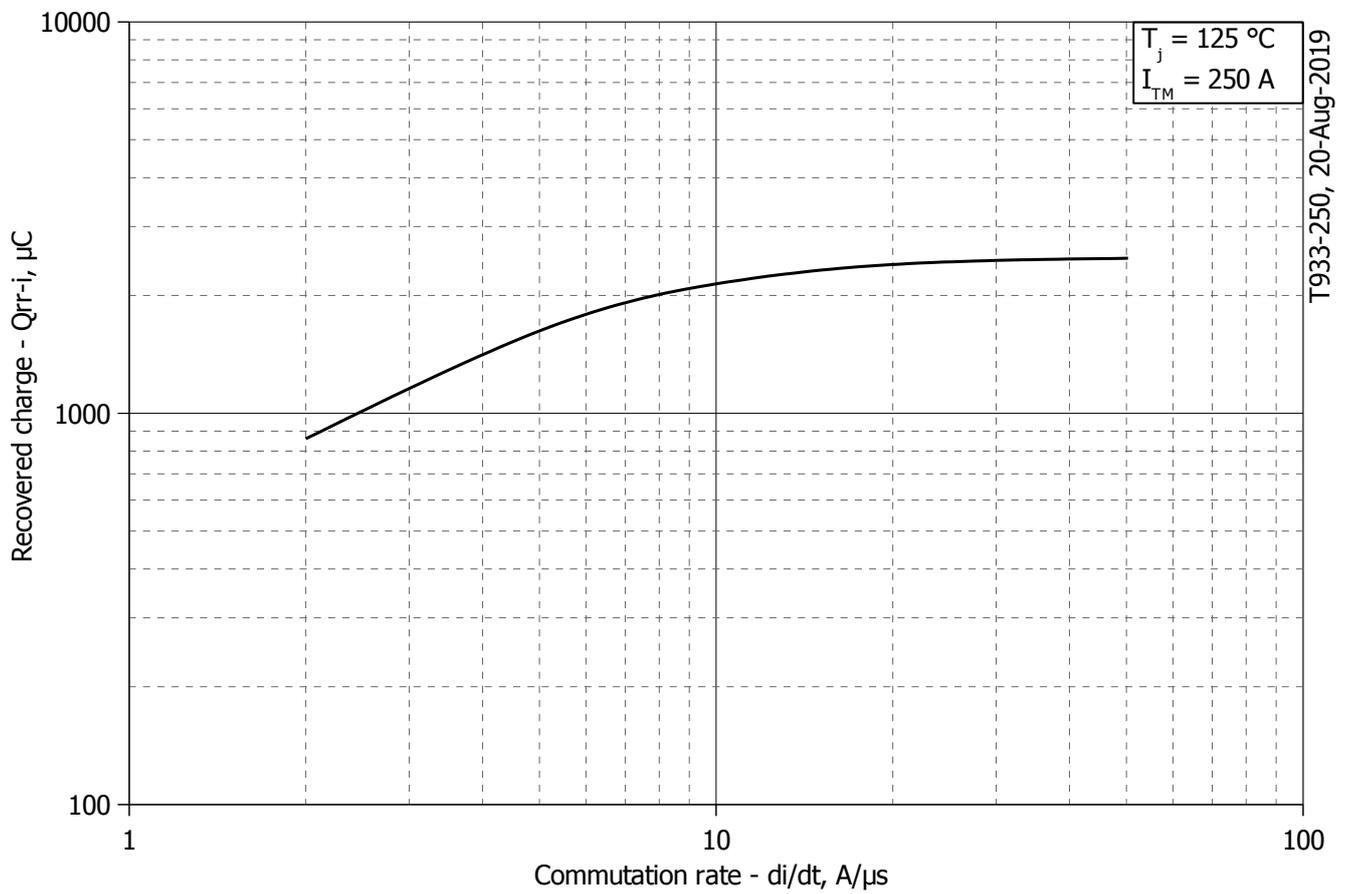
DC Anode side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.04804	0.001789	0.01342	0.02147	0.001374	0.001945
$\tau_i$ , s	2.651	0.4195	0.2622	0.05451	0.002585	0.0005847

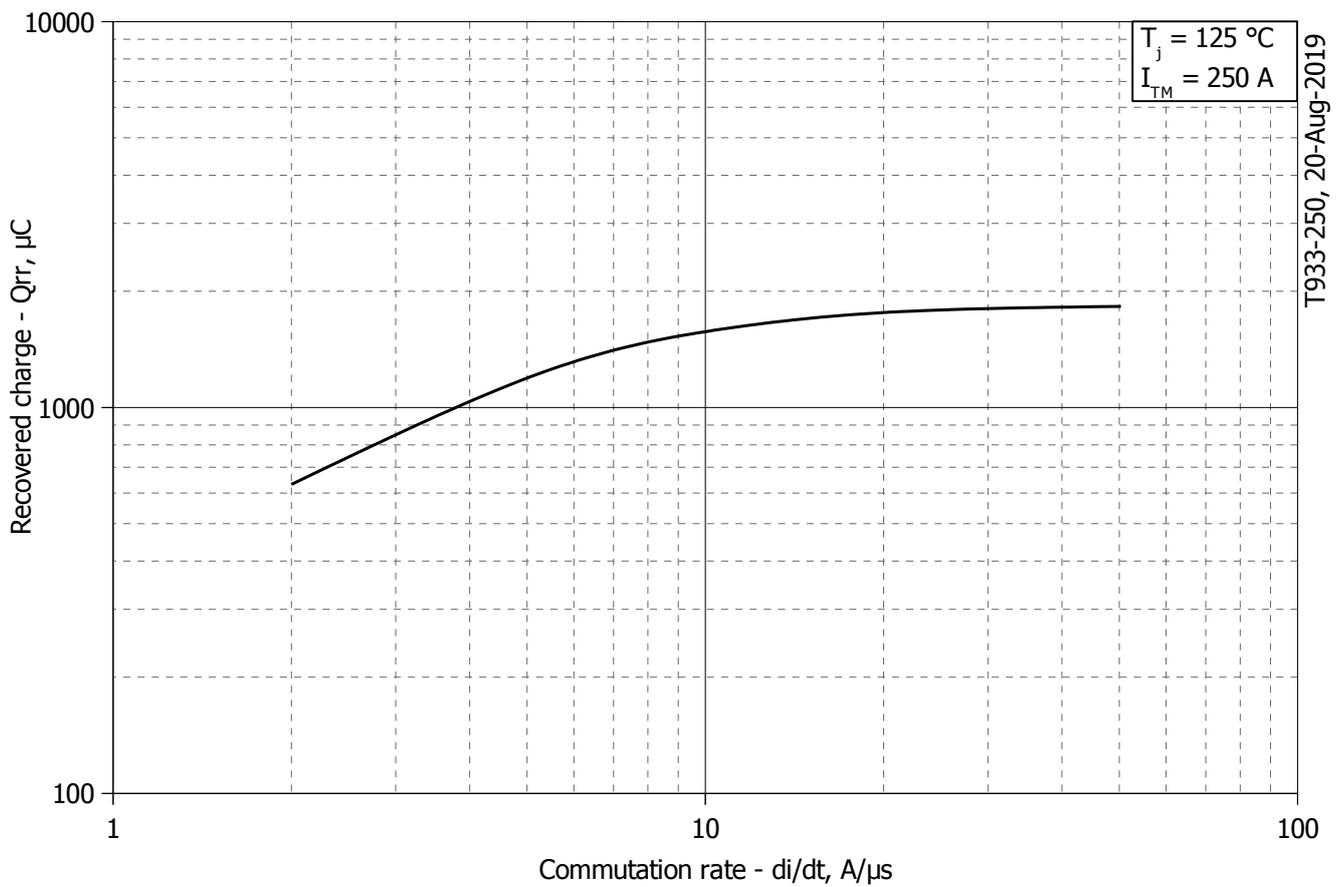
DC Cathode side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.03216	0.01306	0.002934	0.02064	0.001493	0.001786
$\tau_i$ , s	2.647	0.2831	0.1455	0.05284	0.002255	0.0005519

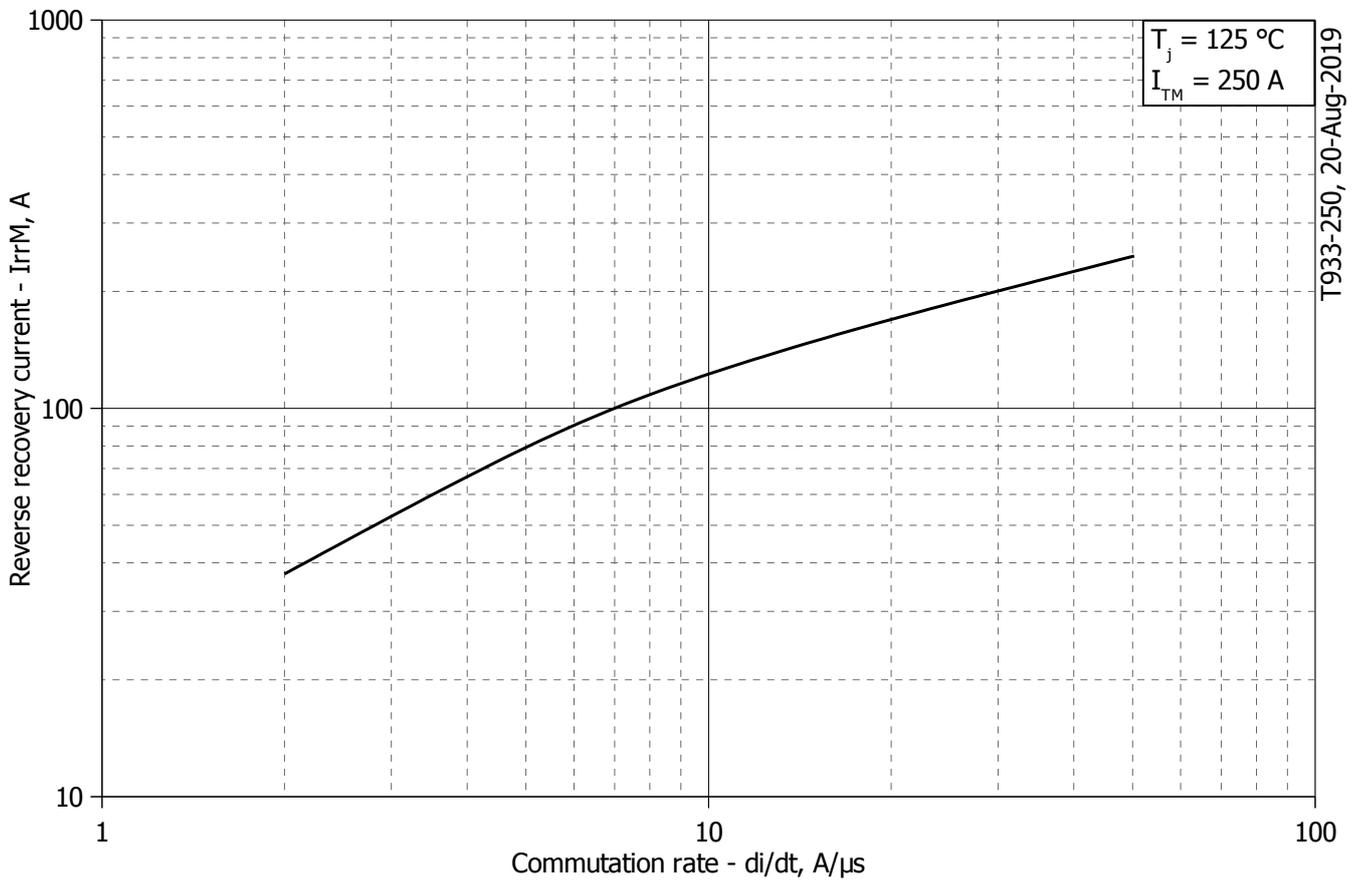
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



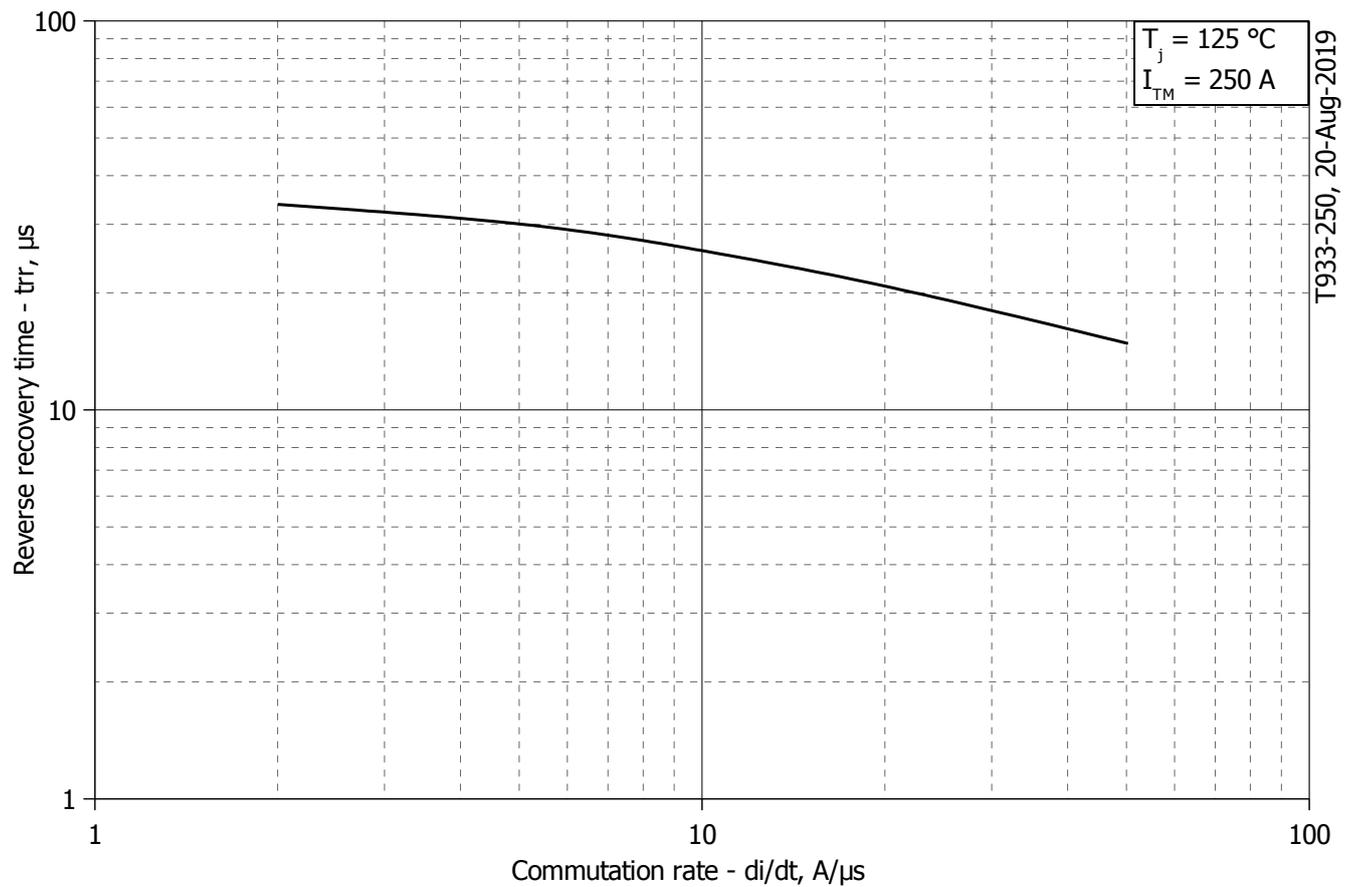
**Fig 3 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $di_R/dt$**



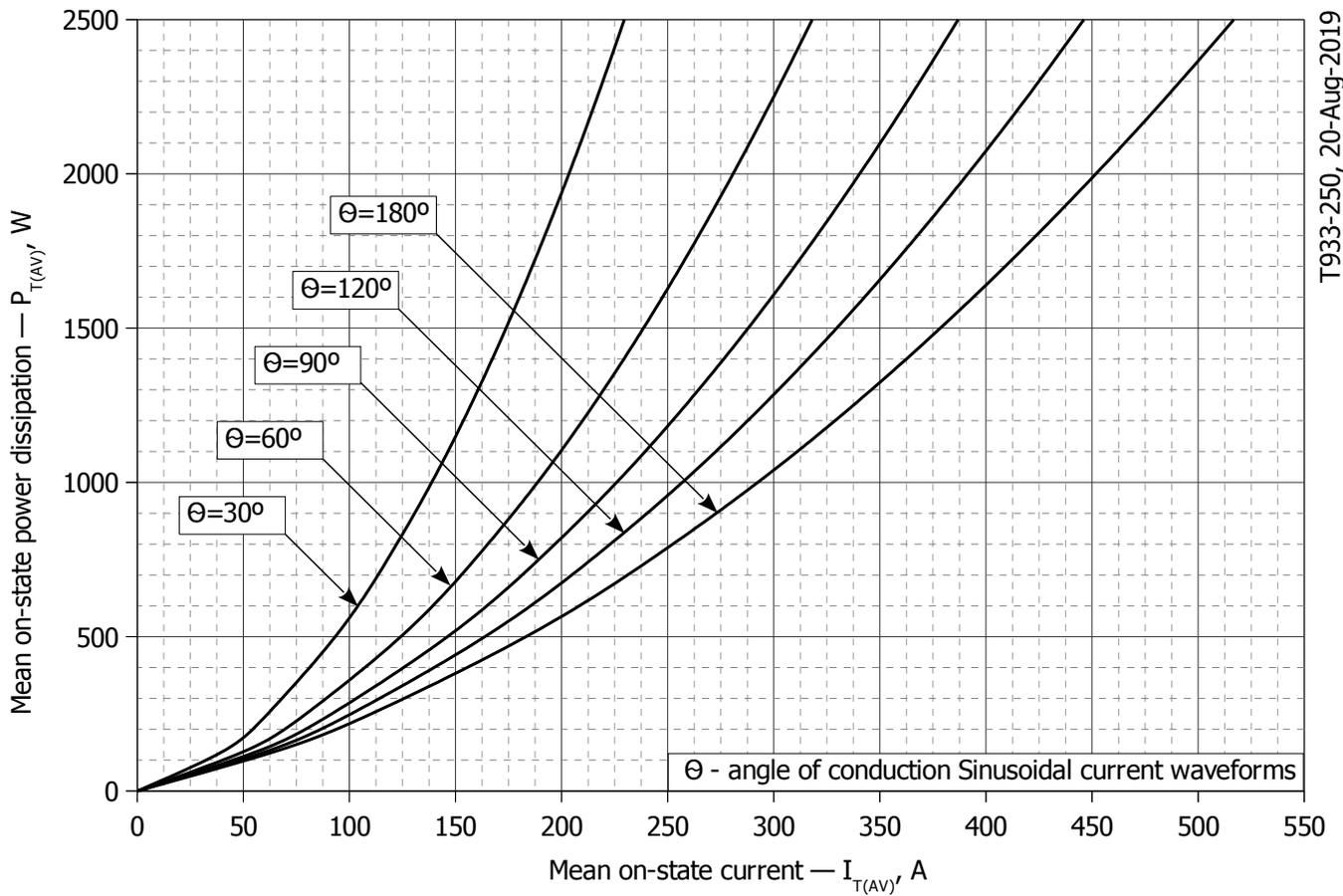
**Fig 4 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**



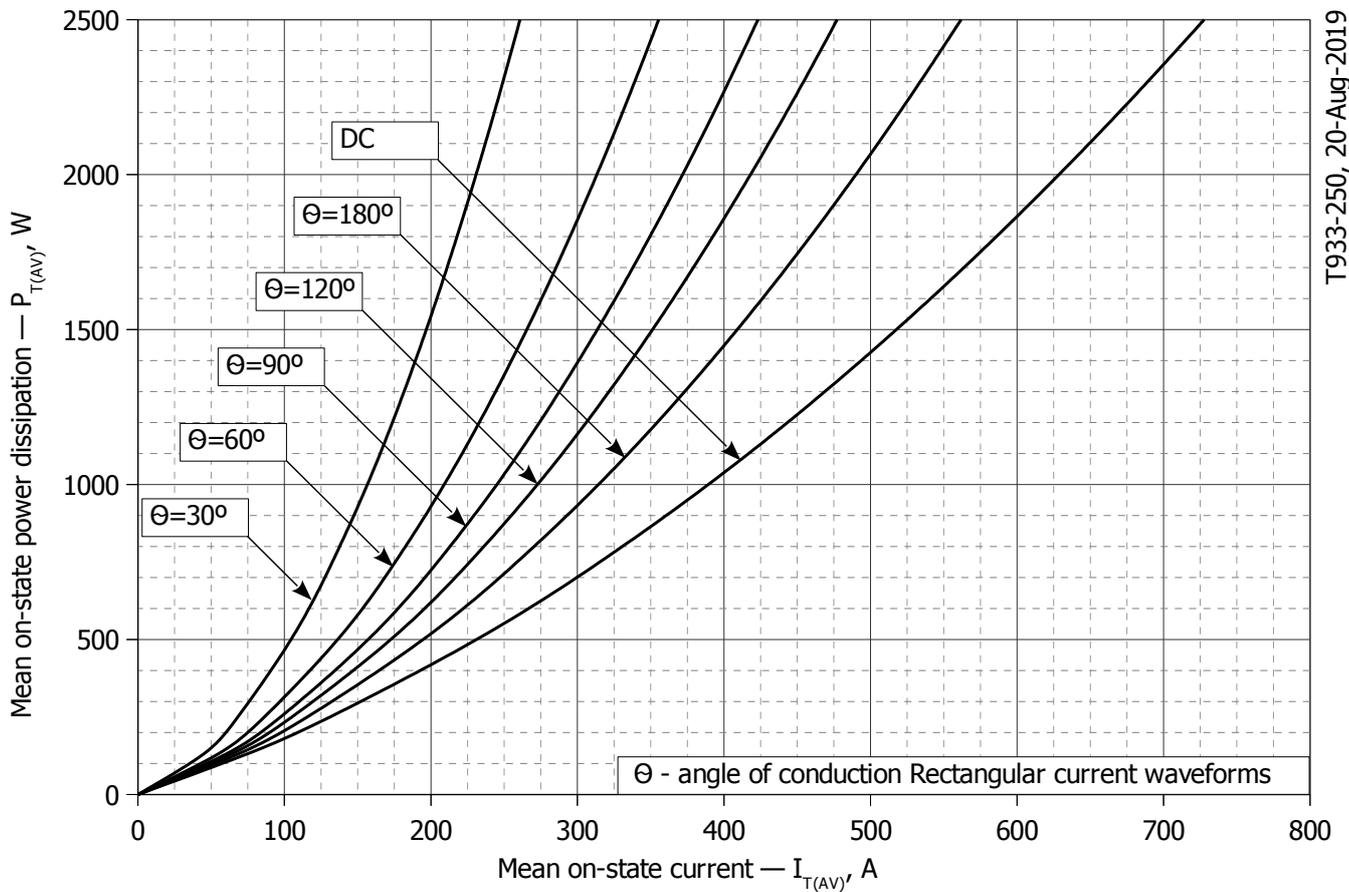
**Fig 5 – Maximum reverse recovery current  $I_{rrM}$  vs. commutation rate  $di_R/dt$**



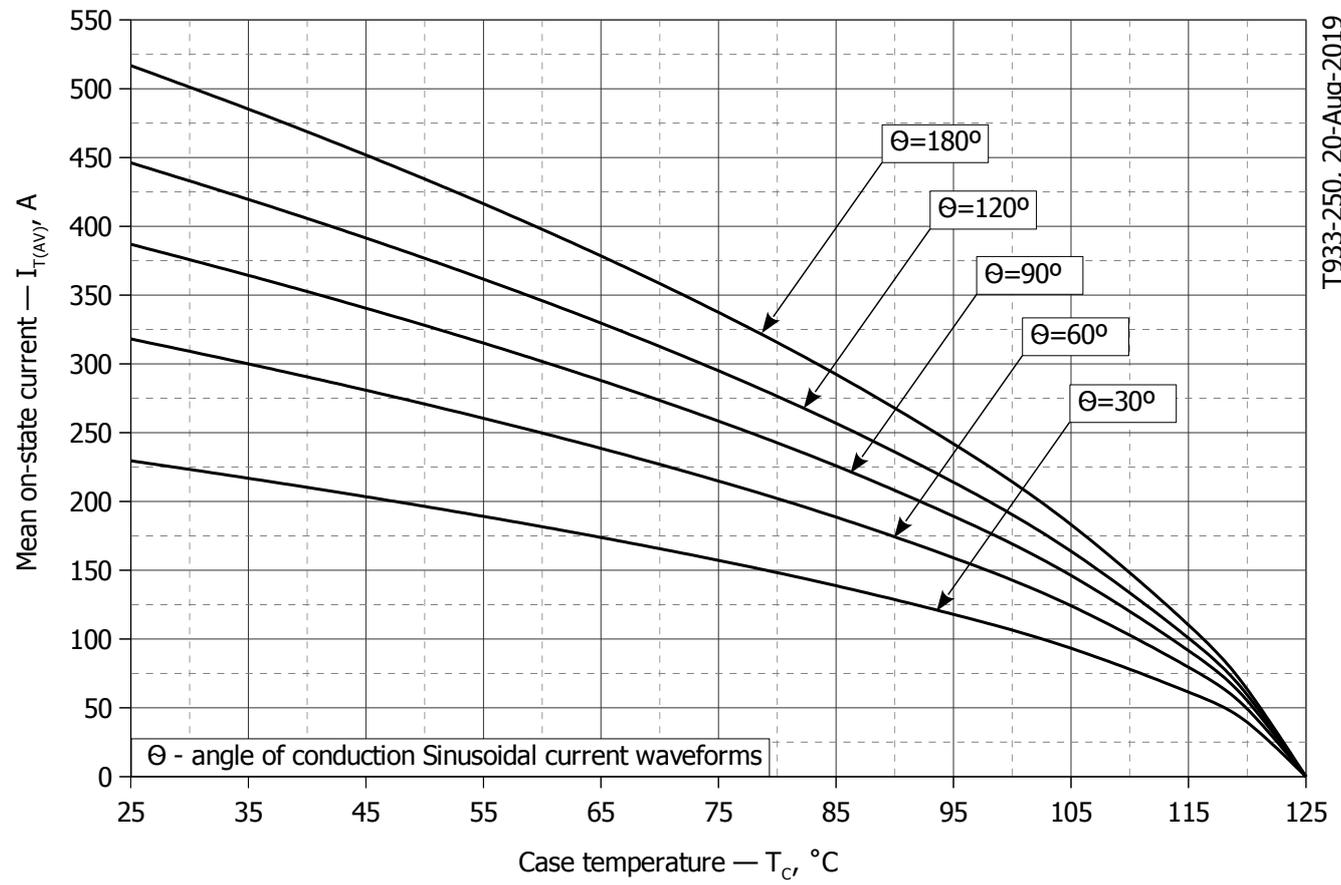
**Fig 6 – Maximum recovery time  $t_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**



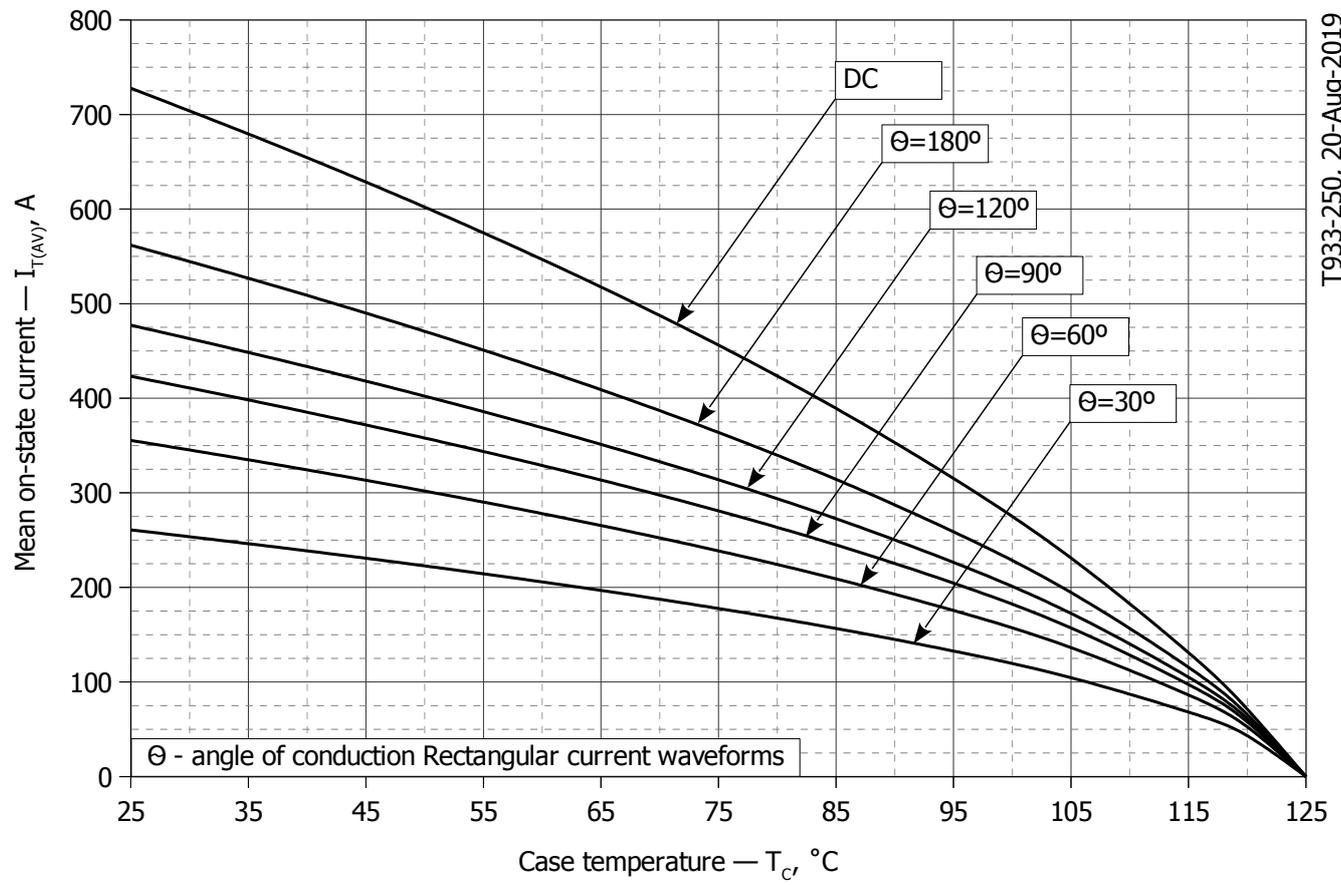
**Fig. 7 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**



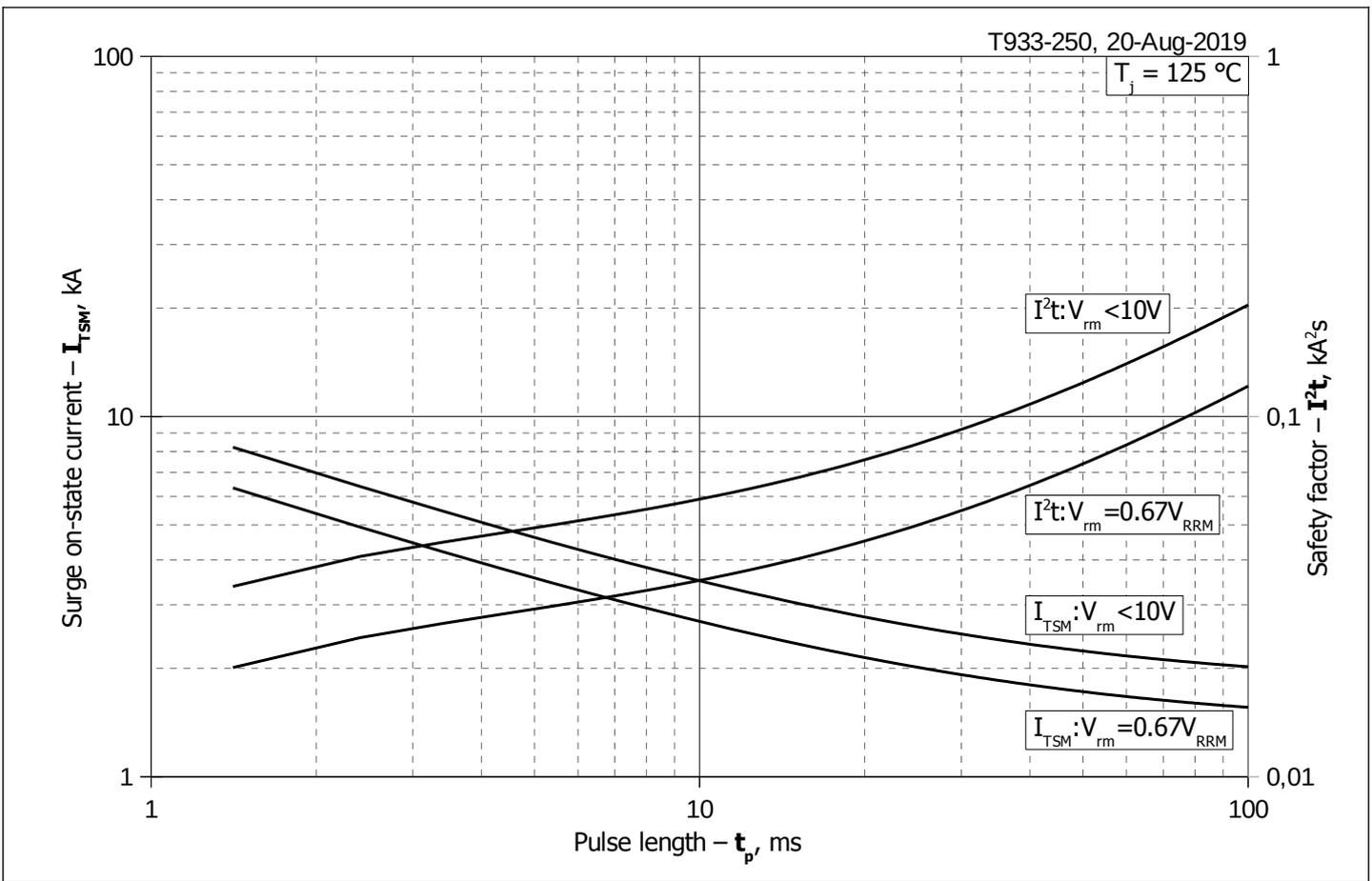
**Fig. 8 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



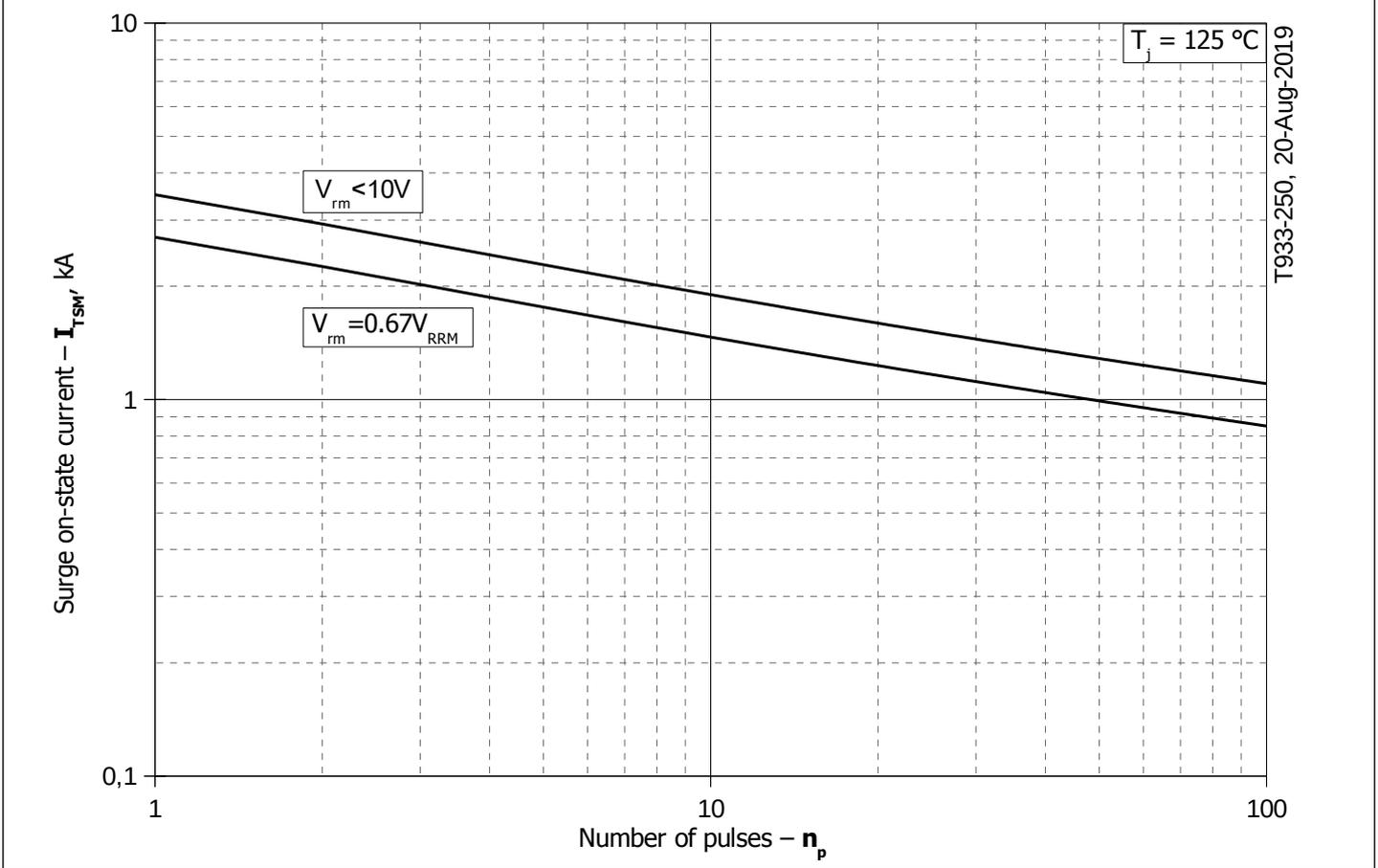
**Fig. 9 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**



**Fig. 10 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



**Fig. 11 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$**



**Fig. 12 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$**